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	1003273 ziving party(icx):
Ronald G. Koelsch Robert Koelsch	Name: WAFER STANDARDS, INC.
Additional numers of convexing partytics) quached ! Yes X no	Internal Address:
3. Nature of Conveyance:	
Assignment Merger  Security Agreement Change of Name	Succt Address: 1835 East 6th Street, Ste. 29
Other	City Tempe, State AZ ZIF 85281
Execution Date: 3-12-99 and 3-24-99	Additional name(s) & address(es) attached? Yes XNo
4 Application number(s) or patent autaber(s):	
	the execution date of the application is: 3-12-99 & 2-24-99
A. Patent Application No.(s)	B. Patent No.(5)
Additional numbers	attached? Yes XNo
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: 1
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Internal Address:	7. Total fee (37 CFR 3.41):
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**REEL: 9860 FRAME: 0882** 

## ASSIGNMENT AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, We, Ronald G. Koelsch and Robert Koelsch, have sold, assigned and transferred and do hereby sell, assign and transfer unto WAFER STANDARDS, INC., and its successors, assigns and legal representatives, the entire right, title and interest for the United States of America in and to certain inventions relating to improvements in "A DEVICE FOR MONITORING AND CALIBRATING OXIDE-CHARGE MEASUREMENT EQUIPMENT AND METHOD THEREFOR" described, illustrated and claimed in an application for Letters Patent of the United States of America, executed by us of even date herewith, together with the entire right, title and interest in and to said application, and in and to Letters Patent which may be issued upon said application, and upon any division, extension, continuation or reissue thereof.

WAFER STANDARDS, INC., the entire right, title and interest in and to said invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of said inventions and said applications for Letters Patent in foreign countries, and we further authorize the said WAFER STANDARDS, INC., to apply for Letters Patent in foreign countries directly in its own name, and to claim the priority of the filing date of the said application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

PATENT REEL: 9860 FRAME: 0883 We hereby authorize and request the Assistant Commissioner of Patents of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation or reissue, to the WAFER STANDARDS, INC., for the sole use and behoof of said WAFER STANDARDS, INC., its successors, assigns and legal representatives, to the full end of the term for which said Letters Patent may be granted, the same as they would have been held and enjoyed by us had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to the said WAFER STANDARDS, INC.

We agree that, when requested, we will, without charge to said WAFER STANDARDS, INC., but at its expense, sign all papers take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for said inventions in all countries and for vesting title thereto in said WAFER STANDARDS, INC., its successors, assigns and legal representatives or nominees.

We convenant with said WAFER STANDARDS, INC., its successors, assigns and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license or other encumbrance.

Dated: 3/12/99

RECORDED: 03/24/1999

Ronald G. Koelsch

Dated: 3-24-99

Robert Koelsch

PATENT REEL: 9860 FRAME: 0884